

for Phase I and Phase II awardees and updated when there is a change in the business regarding the contents of the certification form.

Estimated Number of Respondents: 180.

Annual Responses: 1.

Average time to complete each response: 1 hour.

Burden hours: 180 hours.

Comments: Comments are invited on: (a) Whether the proposed collection of information is necessary for the proper performance of the functions of the Agency, including whether the information will have practical utility; (b) the accuracy of the Agency's estimate of the burden of the proposed collection of information; (c) ways to enhance the quality, utility and clarity of the information to be collected; and (d) ways to minimize the burden of the collection of information on those who are to respond, including through the use of appropriate automated, electronic, mechanical, or other technological collection techniques or other forms of information technology.

All responses to this notice will be summarized and included in the request to OMB for approval. All comments will become a matter of public record.

Obtaining a Copy of the Information Collection: A copy of the information collection and related instructions may be obtained free of charge by contacting Laura Givens as directed above.

Done at Washington, DC this day of June 18, 2026.

Drenda Williams,

Associate Director for Operations, National Institute of Food and Agriculture, U.S. Department of Agriculture.

[FR Doc. 2026-12647 Filed 6-22-26; 8:45 am]

BILLING CODE 3410-22-P

DEPARTMENT OF COMMERCE

Foreign-Trade Zones Board

[Order No. 2182]

Denial of Production Authority; Foreign-Trade Zone 3; Phillips 66 Company; (Renewable Fuels and By-Products); Rodeo, California; Correction

SUMMARY: The **Federal Register** notice published on June 17, 2026, regarding Board Order 2182 not to approve the application submitted to the Foreign-Trade Zones (FTZ) Board by the grantee of FTZ 3, is being corrected.

FOR FURTHER INFORMATION CONTACT:

Juanita Chen at juanita.chen@trade.gov; telephone 202-482-1378.

SUPPLEMENTARY INFORMATION:

Correction

In the **Federal Register** of June 17, 2026, in FR Doc. 2026-12216, on page 36569, the second paragraph, which states "WHEREAS, the San Francisco Port Commission, grantee of FTZ 3, has requested production authority on behalf of Phillips 66 Company, within Subzone 3D in Rodeo, California (B-43-2024, docketed August 8, 2024)" is corrected to read as "WHEREAS, the San Francisco Port Commission, grantee of FTZ 3, has requested production authority on behalf of Phillips 66 Company, within Subzone 3E in Rodeo, California (B-43-2024, docketed August 8, 2024)"

Dated: June 18, 2026.

Juanita Chen,

Acting Executive Secretary.

[FR Doc. 2026-12574 Filed 6-22-26; 8:45 am]

BILLING CODE 3510-DS-P

DEPARTMENT OF COMMERCE

Foreign-Trade Zones Board

[B-27-2025]

Foreign-Trade Zone (FTZ) 102; Authorization of Limited Production Activity; Tight Line Composites, LLC; (Carbon Fiber Profiles for Wind Turbine Spar Caps); Earth City, Missouri

On April 21, 2025, Tight Line Composites, LLC submitted a notification of proposed production activity to the FTZ Board for its facility within Subzone 102H, in Earth City, Missouri.

The notification was processed in accordance with the regulations of the FTZ Board (15 CFR part 400), including notice in the **Federal Register** inviting public comment (90 FR 18954-18955, May 5, 2025). On June 17, 2026, the applicant was notified of the FTZ Board's decision that further review of part of the proposed activity is warranted. The FTZ Board authorized the production activity described in the notification on a limited basis, subject to the FTZ Act and the Board's regulations, including section 400.14, and further subject to a restriction requiring privileged foreign (PF) status (19 CFR 146.41) on all foreign status components. The requirement for PF status will remain even if changes are made to trade measures that separately require PF status.

Dated: June 17, 2026.

Elizabeth Whiteman,

Executive Secretary.

[FR Doc. 2026-12536 Filed 6-22-26; 8:45 am]

BILLING CODE 3510-DS-P

DEPARTMENT OF COMMERCE

Foreign-Trade Zones Board

[B-51-2025]

Foreign-Trade Zone (FTZ) 189; Authorization of Production Activity; Plascore, Incorporated; (Metal, Aramid Paper and Plastic Honeycomb); Zeeland, Michigan

On December 8, 2025, Kent-Ottawa-Muskegon Foreign-Trade Zone, grantee of FTZ 189, submitted a notification of proposed production activity to the FTZ Board on behalf of Plascore, Incorporated, within Subzone 189I, in Zeeland, Michigan.

The notification was processed in accordance with the regulations of the FTZ Board (15 CFR part 400), including notice in the **Federal Register** inviting public comment (90 FR 57731-57732, December 12, 2025). On June 18, 2026, the applicant was notified of the FTZ Board's decision that no further review of the activity is warranted at this time. The production activity described in the notification on a limited basis, subject to the FTZ Act and the Board's regulations, including section 400.14, and further subject to a two-year time period. This two-year time period should be used to assess and qualify a domestic supplier of aramid fiber.

Dated: June 18, 2026.

Juanita Chen,

Acting Executive Secretary.

[FR Doc. 2026-12575 Filed 6-22-26; 8:45 am]

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DEPARTMENT OF COMMERCE

Foreign-Trade Zones Board

[B-9-2026]

Foreign-Trade Zone (FTZ) 70; Authorization of Production Activity; IMRA America Inc.; (Femtosecond Fiber Laser Systems); Ann Arbor, Michigan

On January 19, 2026, the Greater Detroit Foreign-Trade Zone, Inc., grantee of FTZ 70, submitted a notification of proposed production activity to the FTZ Board on behalf of IMRA America, Inc., within FTZ 70, in Ann Arbor, Michigan.

The notification was processed in accordance with the regulations of the

FTZ Board (15 CFR part 400), including notice in the **Federal Register** inviting public comment (91 FR 3104, January 26, 2026). On June 18, 2026, the applicant was notified of the FTZ Board's decision that no further review of the activity is warranted at this time. The production activity described in the notification was authorized, subject to the FTZ Act and the FTZ Board's regulations, including section 400.14.

Dated: June 18, 2026.

Juanita Chen,

Acting Executive Secretary.

[FR Doc. 2026-12567 Filed 6-22-26; 8:45 am]

BILLING CODE 3510-DS-P

DEPARTMENT OF COMMERCE

Foreign-Trade Zones Board

[B-76-2026]

Foreign-Trade Zone (FTZ) 18, Notification of Proposed Production Activity; KLA Corporation; (Semiconductor Wafer Fabrication Tools); Milpitas, California

KLA Corporation submitted a notification of proposed production activity to the FTZ Board (the Board) for its facilities in Milpitas, California within Subzone 18U. The notification conforming to the requirements of the Board's regulations (15 CFR 400.22) was received on June 12, 2026.

Pursuant to 15 CFR 400.14(b), FTZ production activity would be limited to the specific foreign-status material(s)/ component(s) and specific finished product(s) described in the submitted notification (summarized below) and subsequently authorized by the Board. The benefits that may stem from conducting production activity under FTZ procedures are explained in the background section of the Board's website—accessible via www.trade.gov/ftz.

The proposed finished products include: laptops loaded with proprietary software, customizing the functionality to support wired and wireless wafers; racks customized to support defect inspection and metrology tools; remote user stations customized to support defect inspection and metrology tools; camera assemblies used in defect inspection and metrology equipment; cameras kits used in defect inspection and metrology equipment; cameras used in defect inspection and metrology equipment; objective lens used in defect inspection and metrology equipment; objective lenses used in defect inspection and metrology equipment; lenses used in defect inspection and

metrology equipment; mirrors used in defect inspection and metrology equipment; optical lens used in defect inspection and metrology equipment; laser assemblies and subassemblies used in defect inspection and metrology equipment; laser heads in defect inspection and metrology equipment; lasers used in defect inspection and metrology equipment; laser subassemblies designed for specialized or custom applications in advanced defect inspection or metrology systems; laser subassemblies standard defect inspection and metrology equipment; in situ wafer temperature monitoring systems; wafers incorporating embedded temperature sensors, including resistance temperature detectors and thermocouples, for measuring wafer temperature during semiconductor processing; broadband plasma patterned wafer defect inspection subassemblies; reticle defect inspection subassemblies; electron-beam wafer defect review and classification subassemblies; retrofit kits for inspection and metrology equipment; temperature calibration instruments for temperature measurement systems in semiconductor processing; broadband plasma wafer defect inspection assemblies; electron beam wafer defect inspection assemblies; and reticle defect inspection assemblies (duty free).

The proposed foreign-status materials/components include: grease formulations for reducing friction and protecting moving parts in mechanical assemblies; lubricating oils used for hydraulic systems, drive units, and lead screws in machinery; specialty lubricants and greases designed for demanding or unique equipment applications; 300mm lithograph grade wafer; silica solution; alcohol based cleaning kits; heat transfer fluids for temperature control in semiconductor manufacturing applications; perfluorinated polyether dielectric heat transfer fluids; epoxy-based adhesives for use in semiconductor manufacturing applications; granite sealant; clean room grease and lubricants; liquid threadlocking adhesives; photoplotter film; quartz based reticles; 150mm silicon wafers; 200mm silicon wafers; 300mm silicon wafers; chemical reagents used for diagnostic analysis and process monitoring in semiconductor manufacturing; chemical solutions used in wafer processing, cleaning, and surface treatment in semiconductor manufacturing; polymer-based additives used in the formulation and stabilization of process solutions in semiconductor manufacturing; ph buffer

solutions; litmus papers; polyethylene hoses; polyethylene pipes; polyethylene tubes; polypropylene tubing; polyvinyl chloride (pvc) tubing; reinforced plastic tubing for use in metrology inspection tools; plastic tube fittings; insulation tape; masking tape; packaging tape; electrical tape; foam blocks; plastic tool positioning sheets; flexible plastic sheets and strips used in packaging or protective applications; plastic (polyethylene) sheets, films, and strips, including laminated or reinforced forms; fitted plastic storage containers designed for use in manufacturing processes or equipment handling; plastic boxes and cases intended for organizing, storing, or transporting components during production; plastic sacks and bags; plastic bottles; plastic packing materials; plastic brackets; plastic bushings; plastic cable chain; plastic cable tie; plastic clamps; decorative plastic cover for detection machine; plastic ducts; plastic gaskets; plastic hoses; plastic mounts; plastic o-rings; plastic pads; plastic pins; plastic screws; plastic seals; plastic spacers; plastic standoffs; plastic suction cups; plastic timing belts; plastic tubing; plastic washers; plastics clips; rubber pads; unreinforced rubber tubing without fittings; unreinforced rubber tubing with fittings; drive belts made of rubber; rubber belt, reinforced with synthetic fibers, for industrial automation; transmission belts made of rubber; endless rubber timing belt for industrial machinery; endless rubber timing belt with textile reinforcement for industrial equipment; open-ended rubber timing belt for machinery or conveyors; specialty rubber timing belt, not endless, for industrial applications; nitrile gloves included in tool installation kits; rubber gaskets; rubber seals; rubber washers; rubber seals, gaskets, and o-rings used in vacuum systems in metrology equipment; rubber vacuum pads and tips used for wafer handling in metrology equipment; rubber mounts and shock absorbers used for vibration control in metrology equipment; hard plastic cases; paper labels; lens cleaner wipes used in tool installation kits; technical manual, procedures, and work instructions; cleaning swabs included with tool installation kits; cleaning pads included with tool installation kits; fiber optic cleaning wipes included with tool installation kits; granite slab; ceramic covers; ceramic machinery chambers; ceramic machinery screws; ceramic nozzles; ceramic plugs; ceramic shields; ceramic cylinders; glass substrate for technical or laboratory use, without surface finishing or coatings; glass